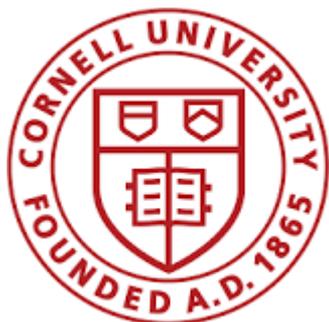




FARADAY 
TECHNOLOGY, INC.

Activities Directed Towards HF-FREE ElectroPolishing of Niobium SRF Cavities

Acid-Free Electropolishing of SRF Cavities
NP Phase II Grant No. DE-SC0011235



Faraday Technology, Inc.

Maria Inman, PhD; P.I.

Tim Hall, PhD; Project Lead

E. J. Taylor, PhD; Founder & Chief Technology Officer

Cornell University

Fumio Furuta, PhD; Research Associate

CRADA No. DE-AC05-06OR23177

Thomas Jefferson National Accelerator Facility

Hui Tian, PhD; Staff Scientist

Charles Reece, PhD; Senior Staff Scientist

Larry Phillips, PhD; Senior Staff Scientist

August 9, 2017



U.S. DEPARTMENT OF
ENERGY

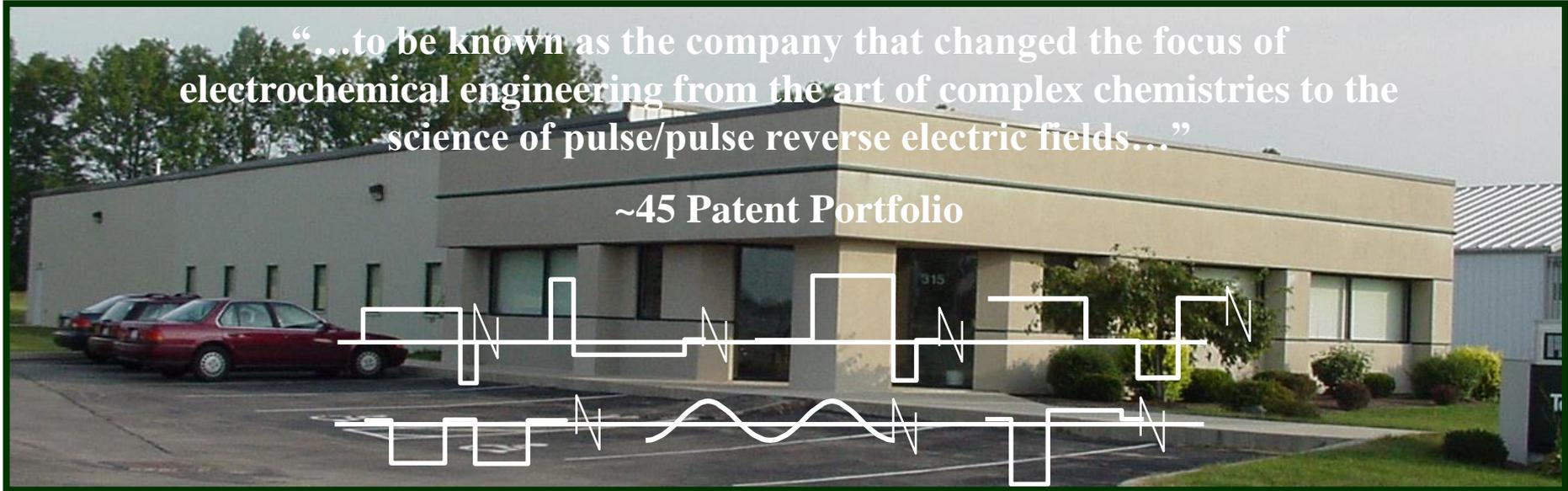
Office of
Science

Marialnman@FaradayTechnology.com
TimHall@FaradayTechnology.com
JenningsTaylor@FaradayTechnology.com

Company Overview: FARADAY TECHNOLOGY, INC.

“...to be known as the company that changed the focus of electrochemical engineering from the art of complex chemistries to the science of pulse/pulse reverse electric fields...”

~45 Patent Portfolio



- Electrochemical engineering processes and technologies – founded 1991
 - In particular, pulse & pulse reverse electrolytic processes
 - ~30 Issued Patents and ~15 Pending Patents in this area
- Perspective
 - PhD in electrochemical kinetics, MS in Technology Strategy, Patent Bar
- www.FaradayTechnology.com

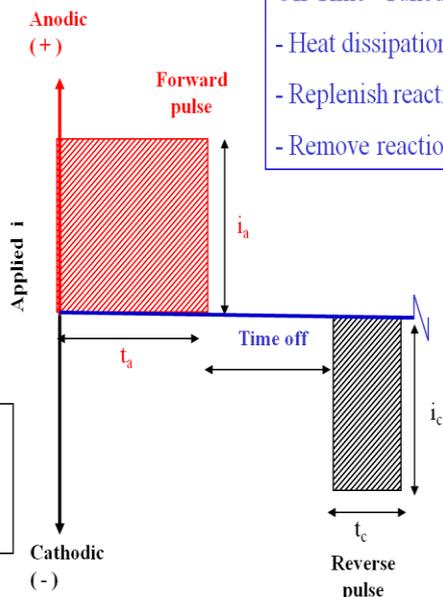
Vision: Pulse Current/Pulse Reverse Current

“...to be known as the company that changed the focus of electrochemical engineering from the art of complex chemistries to the science of pulse/pulse reverse electric fields...”

Electrochemical Machining, Polishing, Deburring, Through-Mask Etching

Anodic Pulse “Tuned” to:

- Control current distribution
- Eliminates need for viscous, low water content electrolytes



Off-Time “Tuned” to:

- Heat dissipation
- Replenish reacting species
- Remove reaction products

Cathodic Pulse “Tuned” to:

- Reduce oxide/depassivate surface
- Eliminate need for HF

- 2008 Blum Award for Pulse Reverse Finishing
- 2016 R&D 100 Finalist for Nb EP

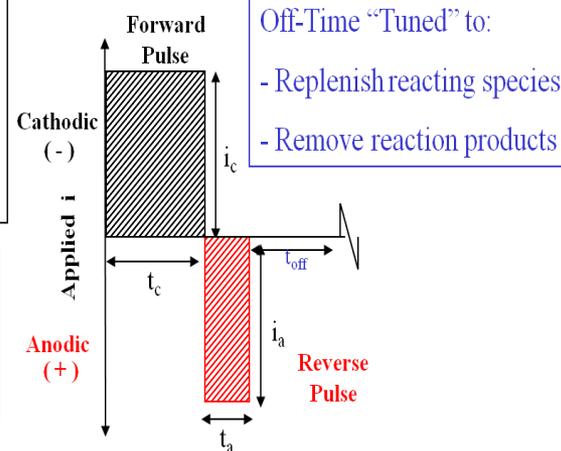
Electrodeposition/Plating

Cathodic Pulse “Tuned” to:

- Enhance mass transfer
- Control current distribution
- Simplify chemistry

Anodic Pulse “Tuned” to:

- Remove H₂ effects
- Acidify interface

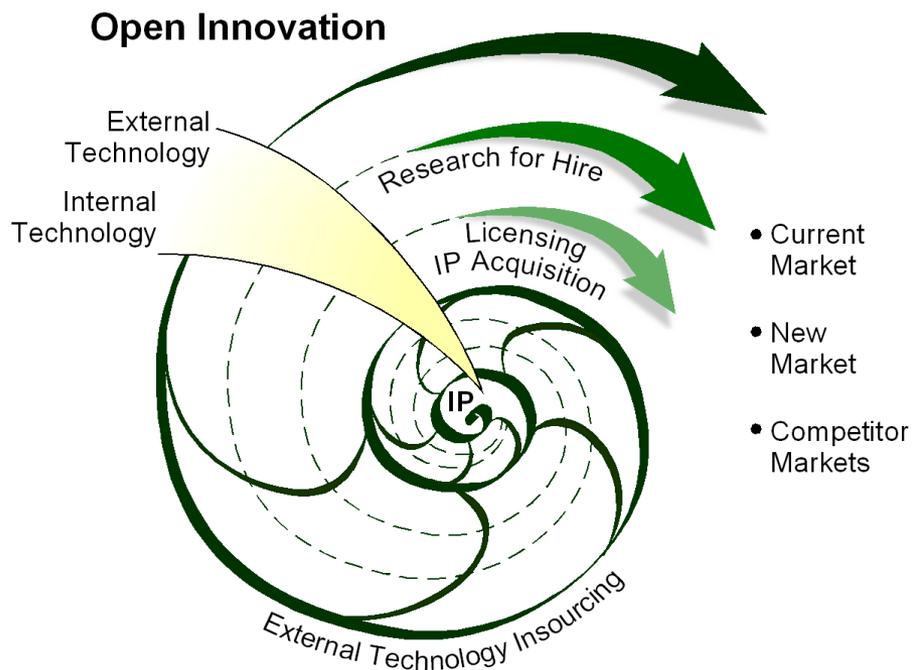


Off-Time “Tuned” to:

- Replenish reacting species
- Remove reaction products

- 2011 R&D 100 for Co-Mn Alloy Plating
- 2013 Presidential Green Chemistry Challenge award for Cr⁺³ Plating

Business Model: Open Innovation



Development of robust process is critical!

- Leverage Federal SBIR opportunities as non-equity technology funding
 - Retain IP rights
 - Establish IP (30 US patents issued)
 - Collaborate universities/government labs
 - Develop electrochemical engineering solutions based on PC/PRC processes
 - Transition technology & competitive advantage to large companies via
 - DEM/VAL; α -scale to β -scale
 - Field-of-use licenses
 - Patent acquisition (8)
 - Transition of technology for Federal use
 - DEM/VAL; α -scale to β -scale
 - Insertion at Lab or “logistics” center
 - Transition of ElectroPolishing technology to physics community
 - DEM/VAL; α -scale to β -scale
 - Geographic License; US, Japan, Europe
 - “Build to Print” market
- Key: β -scale DOE Lab validation

Background: SRF Niobium Cavity Electropolishing (EP)

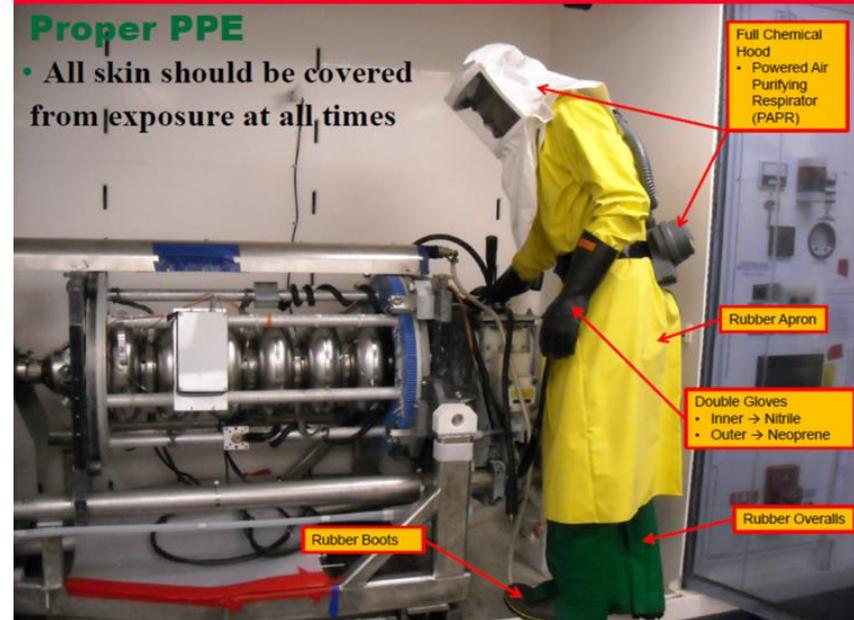
Nb Superconducting Radio Frequency (SRF) are required for the International Linear Collider as well as other high energy physics projects. To achieve required particle acceleration gradients, electropolishing is the final surface finishing operation;

**9:1 H₂SO₄ (98%) : HF(48%)
electrolyte (DC)
“High Viscosity”**

HF → Safety/Cost Burden

Personal Protective Equipment (PPE) for “conventional” SRF niobium cavity electropolishing using sulfuric acid – hydrofluoric acid mixture.

John Mammoser, Instructor
“Chemical Safety for SRF Work”
U.S. Particle Accelerator School
January 2015



T. Dote, K. Kono(2004), “An Acute Lethal Case of Exposure During A Washing Down Operation of A Hydrogen Fluoride Liquefying Tank”, *Japanese Journal of Occupational Medicine and Traumatology*, **52**, 3, pp189-192.

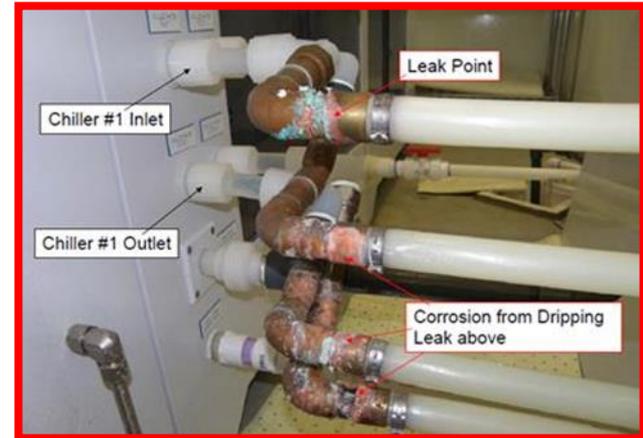
Background: Electropolishing Niobium SRF Cavities

*Nb Superconducting Radio Frequency (SRF) are required for the International Linear Collider as well as other high energy physics projects. To achieve required particle acceleration gradients, **electropolishing** is the final surface finishing operation;*

**9:1 H₂SO₄ (98%) : HF(48%)
electrolyte (DC)
“High Viscosity”**

**HF → Safety/Cost Burden
Corrosive**

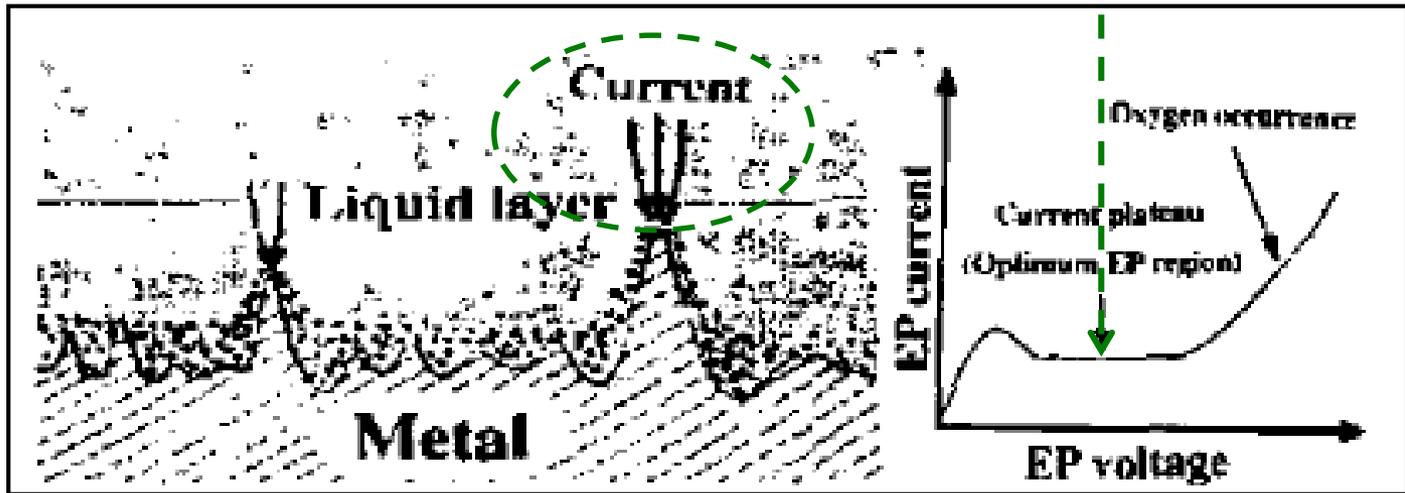
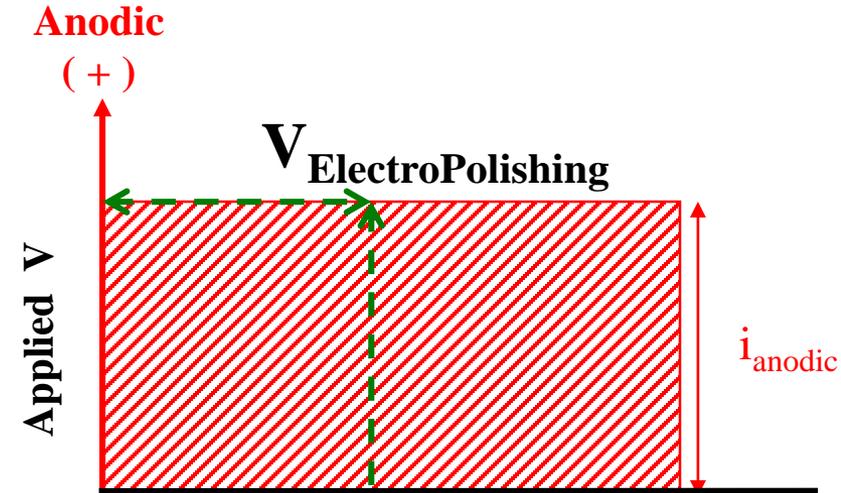
**“...well known...
viscous salt film paradigm”**



- Rectification:
 - DC - Constant voltage
 - Viscous salt film per Jacquet
- Electrolyte:
 - Concentrated/viscous acid
 - Chilled to increase viscosity

→ *Thick boundary layer*

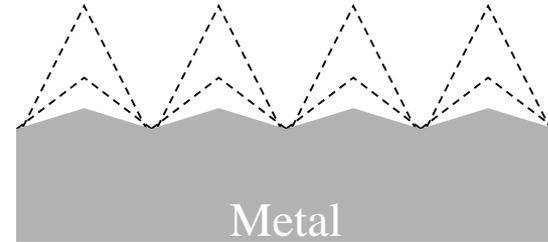
→ *Mass transport control to focus current on peaks (tertiary current distribution)*



† P.A. Jacquet, *Trans. Electrochem. Soc.*, **69** 629 (1936).



- 1st Issue: **Viscous/chilled solutions** – Jacquet Paradigm:



→ **Thick/viscous boundary with concentrated H₂SO₄**

- 2nd Issue: Polishing oxide forming materials:



- **Oxide removal with fluoride or hydrofluoric acid (HF)**
 - **challenging control/safety issues associated with HF**
- **Non-aqueous electrolytes[†] < 5% H₂O**
 - **limited industrial implementation (NiTi stents)**

P. Kneisel, “High Gradient Superconducting Niobium Cavities: A Review of the Present Status” *IEEE Trans. Appl. Superconductivity*, 9(2) 1023-1029 (1999).

J.B. Mathieu, D. Landolt “Electropolishing of Titanium in Perchloric Acid-Acetic Acid Solutions” *J. Electrochem. Soc.* 125(7) 1044 (1978).

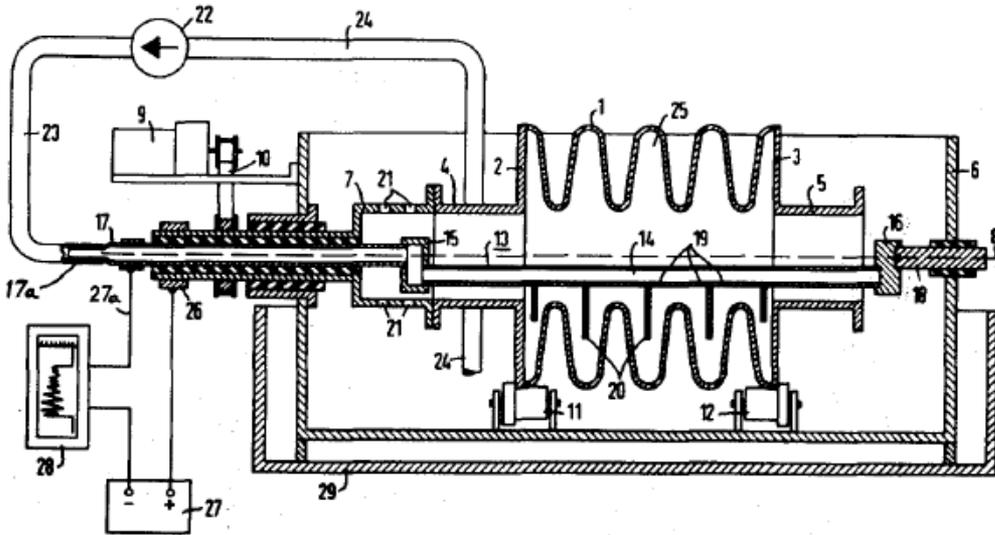
US Patent No. 4,014,765 (Siemens)

Problem of ...

“...electrolytic polishing hollow niobium bodies of a **complicated geometrical structure** ...where development of gases...rise from the cathode...forming **gas pockets** ...resulting in portions of the **inside surface not polished**...”

...is solved by...

“...**horizontally orienting** the hollow niobium **body**...**partially filling** said hollow body with polishing solution and slowly **rotating** said hollow body...”



Note;
electrode “fins” to level current distribution disclosed – only recently considered by the particle physics community?



➔ *Horizontal operation adds significant capital cost in cavity processing tools and hinders process industrialization!*

Anodic Pulse “Tuned” to:

- Focus current distribution

→ Eliminates need for viscous electrolytes

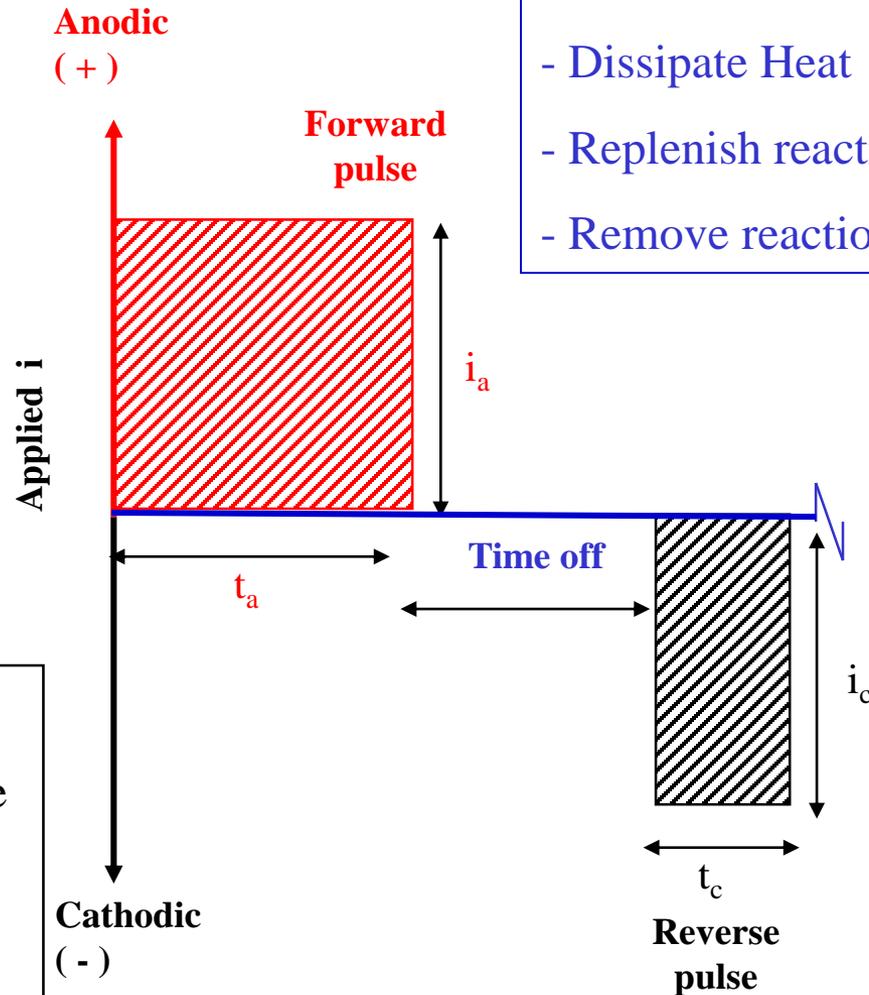
Cathodic Pulse “Tuned” to:

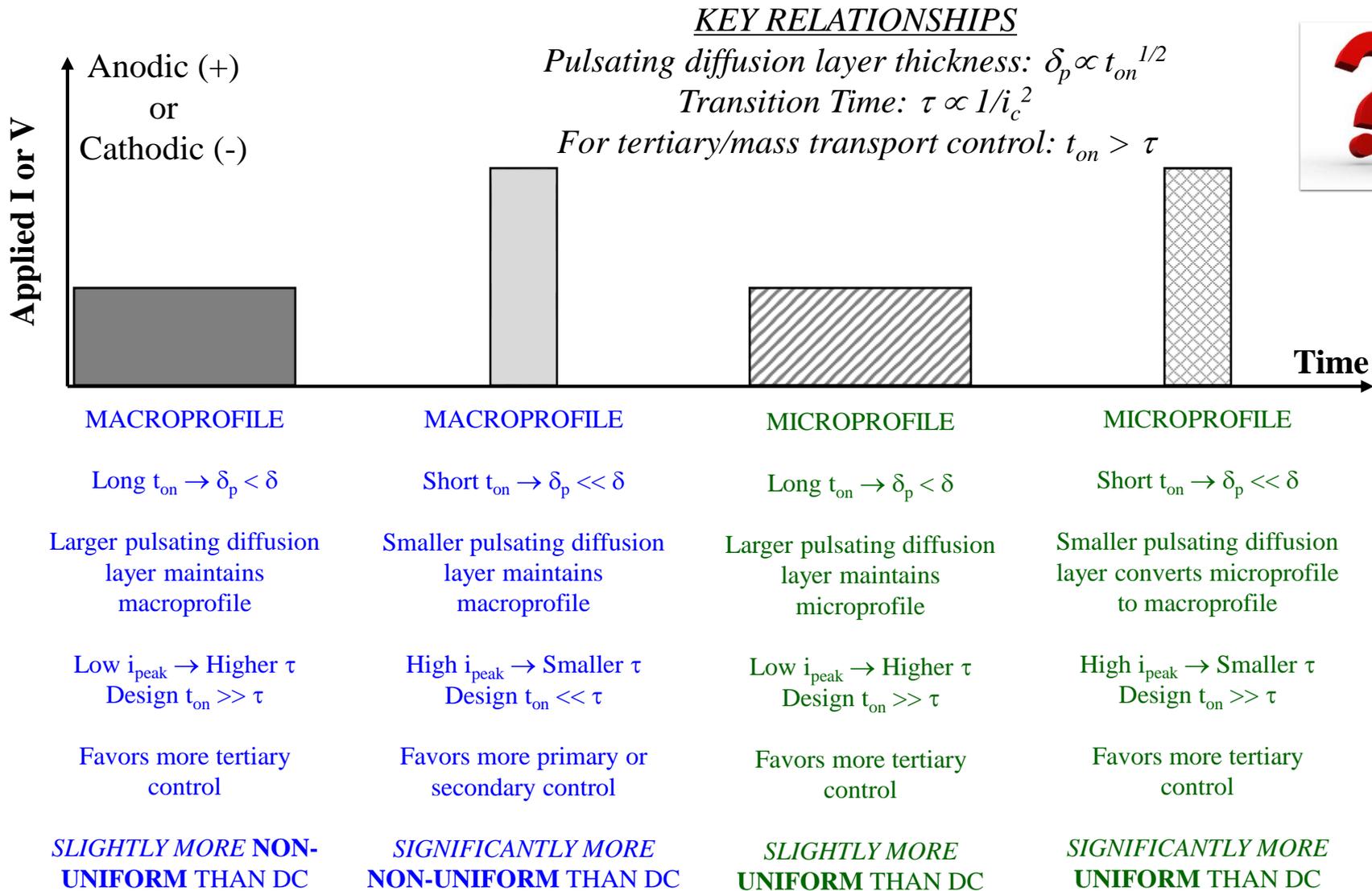
- Depassivate surface/remove oxide

→ Eliminate need for HF, and/or low water content electrolytes?

Off-Time “Tuned” to:

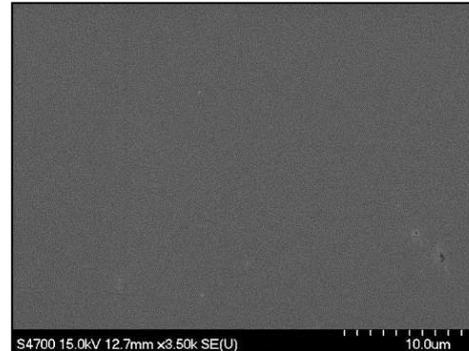
- Dissipate Heat
- Replenish reacting species
- Remove reaction products



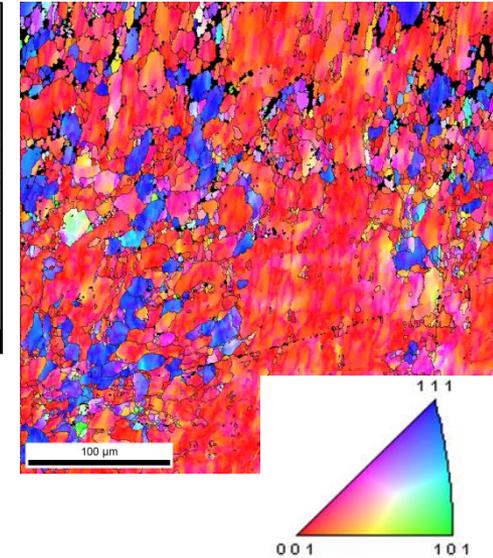


- Pulse/Pulse Reverse - coupons
 - Aqueous H₂SO₄ electrolyte (5 to 30%)
 - Strong Passive film
 - ➔ Forward (anodic) pulses
 - ➔ Reverse (cathodic) pulses
 - Fast Waveforms
 - Bulk removal (100μm)
 - ~0.5-1μm/min
 - Slower Waveforms
 - Final EP (25μm)
 - ~0.03-0.3μm/min
 - R_a < 0.05μm (stylus)
 - Extremely clean surface

SEM Image



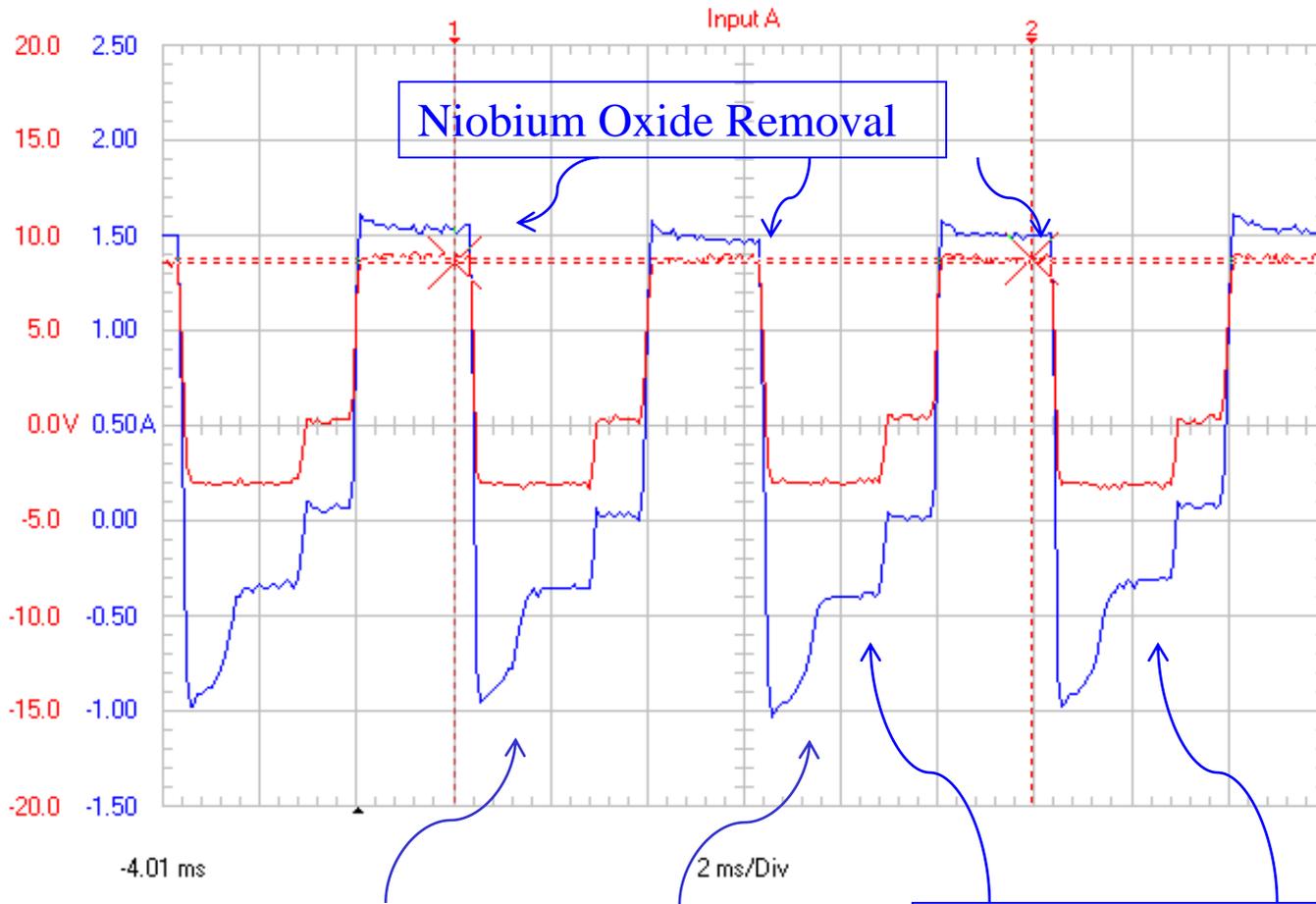
EBSD Profile



Scan size μm	Scan No.	R _{max} nm	R _a nm	RMS nm
50x50	1	35.00	2.71	3.34
	2	37.30	3.54	4.73
	3	69.66	3.74	4.69
10x10	1	22.59	2.25	2.87
	2	16.16	0.41	0.54
2x2	1	9.42	0.36	0.46

Dr. C. Reece, T. Jefferson lab

“...comparable to standard HF EP...”



Datablock	
Name	= Input A
Date	= 8/15/2011
Time	= 9:14:18 AM
Y Scale	= 5 V/Div
Y At 50%	= 0.0 V
X Scale	= 2 ms/Div
X At 0%	= -4.01 ms
X Size	= 300 (300)
Maximum	= 9.6 V
Minimum	= -3.8 V

Cursor Values	
X1	: 1.99 ms
X2	: 13.91 ms
dX	: 11.92 ms
Y1	: 8.6 V
Y2	: 8.8 V
dY	: 0.2 V

Anodic: 3V 2.5 ms
off: 1.0 ms
Cathodic: 9V 2.5 ms



Transition from oxide formation to oxygen evolution?

Anodic current transition correlates with effective electropolishing!

†M. Inman, E.J. Taylor, T.D. Hall “Electropolishing of Passive Materials in HF-Free Low Viscosity Aqueous Electrolytes” *J. Electrochem. Soc.*, **160**(9) E94-E98 (2013).



Pulse Reverse EP Studies

- Vertical (electrolyte “dump” mode)
- 100% Volume Fill
- No Rotation
- 5-10 wt% H_2SO_4 in H_2O

➔ Analogous to plating of IDs

➔ Simpler/Industrial Compatible

➔ *Enabled by low viscosity electrolyte!*

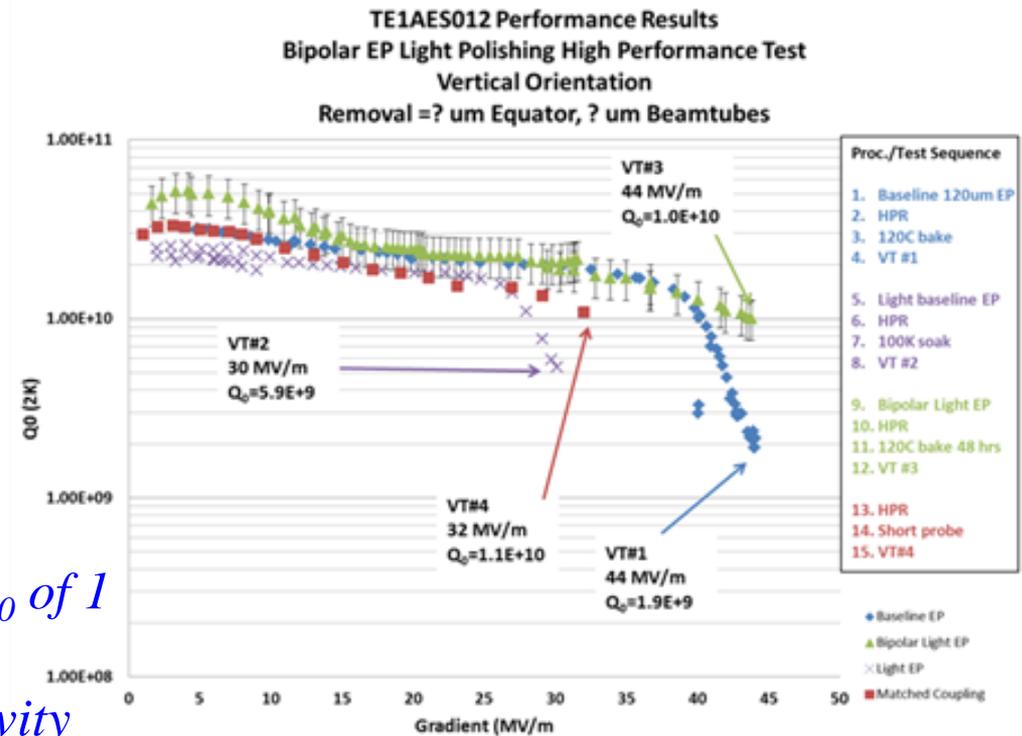


“BiPolar EP” (PRC)

- Vertical
- 100% Volume Fill
- No Rotation
- 10 wt% H₂SO₄ in H₂O

➔ 25 μm removed “light EP”

➔ *Cavity achieved a maximum gradient of ~44 MV/m with a Q₀ of 1 X 10¹⁰, the highest gradient observed at Fermilab in any cavity regardless of processing technique.*



†E.J. Taylor, T.D. Hall, M. Inman, S. Snyder “Electropolishing of Niobium SRF Cavities in Low Viscosity Aqueous Electrolytes without Hydrofluoric Acid” Paper No. TUP054, Presented SRF2013, Paris, FRANCE Sept. 2013.

†A.M. Rowe, A. Grassellino, T.D. Hall, M.E. Inman, S.T. Snyder, E.J. Taylor “Bipolar EP: Electropolishing without Flourine in a Water Based Electrolyte” Paper No. TUIOC02, Presented SRF2013, Paris, FRANCE, 2013.



FARADAY TECHNOLOGY, INC. Commercialization: "Market Acceptance"

ORNL

- P.O. for Nb coupons (\$5K)
- P.O. for 3-cell Nb cavity electropolishing

"...very good results."

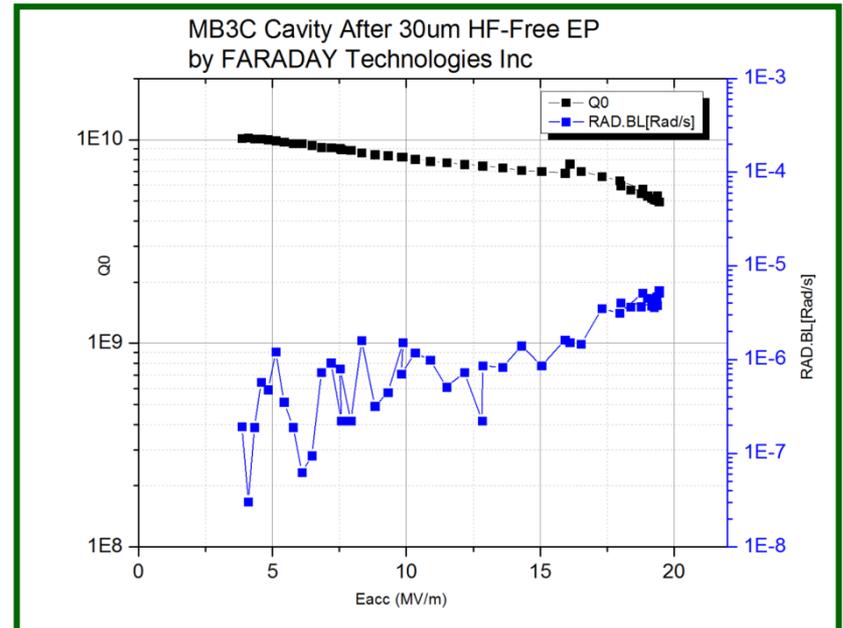
J. Mammosser

Prototype Medium Beta 0.61 805MHz for SNS

- P.O. for EP apparatus (\$80K)



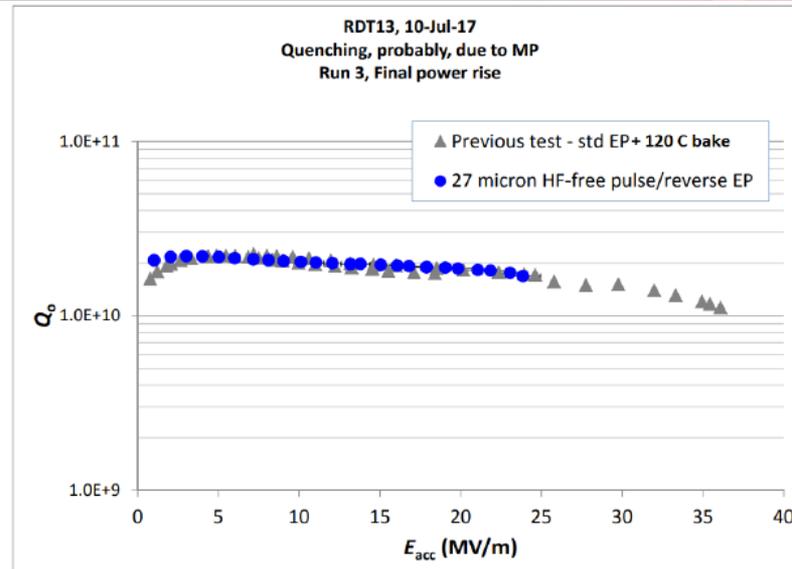
Approximate height of 9-cell cavity



Jefferson National Accelerator Facility CRADA No. DE-AC05-06OR23177

- α -Scale (at Faraday) FARADAYIC[®] EP of “N₂ doped” single cell Nb Cavity
→ SUCCESS!
- β -Scale (at Jlab) FARADAYIC[®] EP of single cell Nb Cavity
→ SUCCESS!
- β -Scale (at Jlab) FARADAYIC[®] EP of single cell N₂ doped Nb Cavity
→ UNDERWAY -

Nb SRF cavity process with pulse/pulse reversed EP at Jlab



The process of N doped single cell and multi cell Nb cavity is underway for pulse/pulse reversed EP.

The parametric optimization is needed to explore ways towards higher Q₀ and higher yield with pulse/pulse reversed EP.



The progress of Vertical EP and Pulse/Pulse Reversed HF Free EP

Hui Tian

Jefferson Lab, Newport News, VA, USA
SRF2017, Lanzhou China

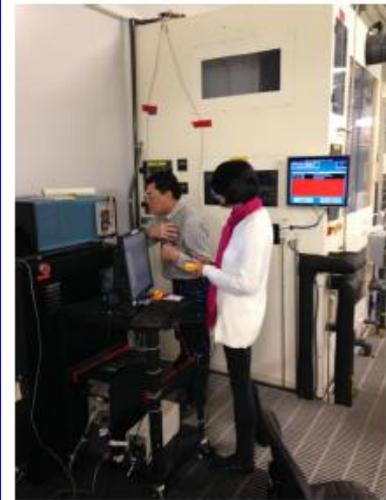
Highlighted work at Faraday, Jlab, and KEK on pulse reverse EP



Jlab HF-free pulse/pulse reversed EP development



The pulse reversed EP process uses a custom designed IGBT driver pulse controller to drive two DC power supplies (AMETEK 40V, 250A) to provide the positive and negative pulses. Pulse/pulse reversed electropolishing for single/multicell Nb cavities conducts in the closed chemistry VEP cabinet .



The in-house pulse reversed EP process system demonstrates its capability for higher pulse current, longer pulse duration – multi-cell & different structure SRF Nb cavity .

Focused on low-cost rectifier development

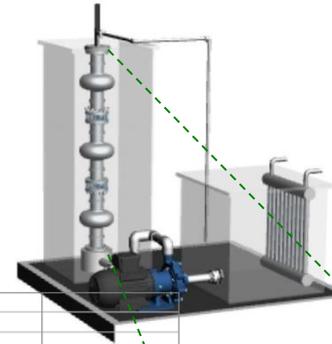
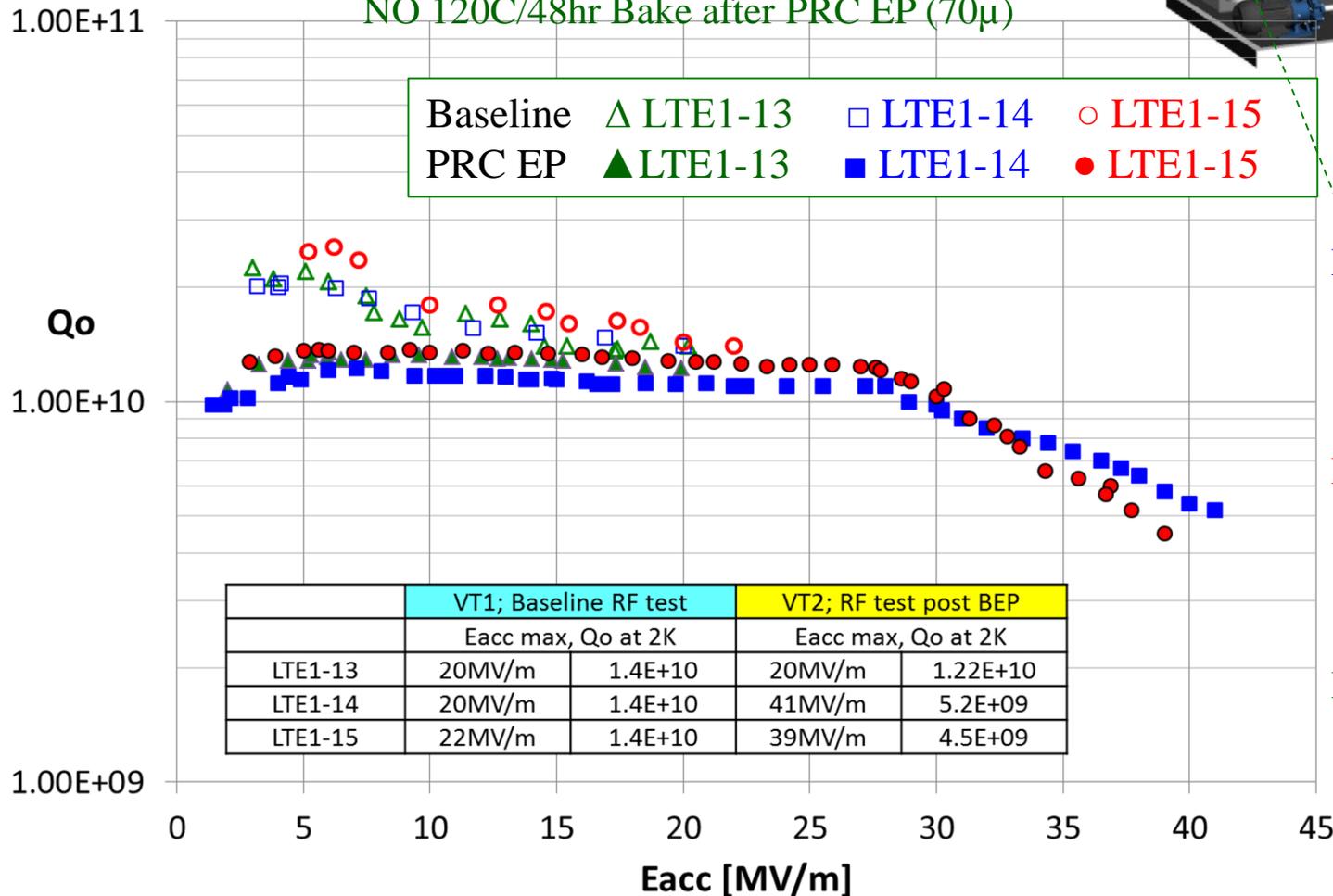
A CEBAF shape single cell and a ILC shape single cell cavity have been processed by pulse/pulse reversed EP for VTA test.

Three single-cell Nb SRF cavities

- Stacked with “spacers” to simulate nine-cell cavity height/flow effects: 9-cell 1250mm; stacked-cell 1200mm

2K Test

NO 120C/48hr Bake after PRC EP (70 μ)



LTE1-14

LTE1-15

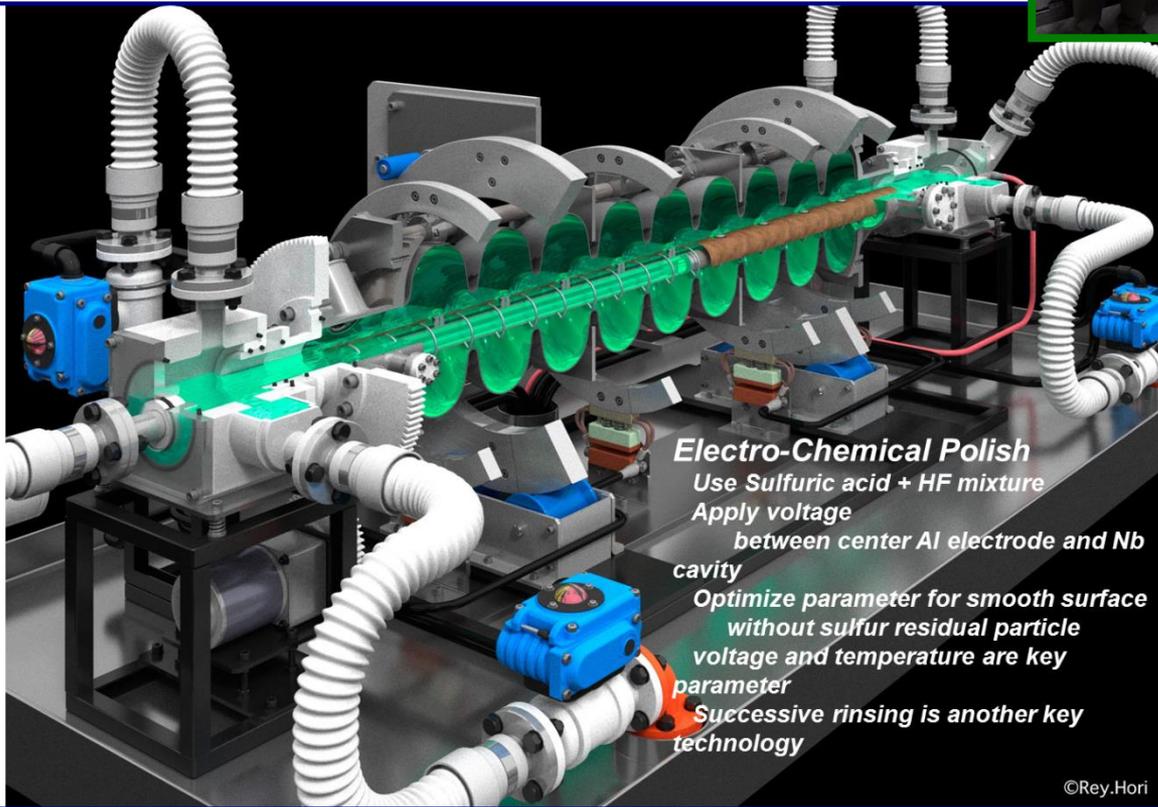
LTE1-13

Based on 3-cell stack result, KEK provided

- α -Scale (at Faraday) FARADAYIC[®] EP of Nine cell Nb Cavity

➔ RESULTS PENDING

Electro-Chemical polishing inside 9-cell





Study on Electro-Polishing of NB Surface By Periodic Reverse Current Method with Sodium Hydroxide Solution for Particle Accelerator Application

Highlighted work at Jlab, and KEK on pulse reverse EP

T. Saeki, H. Hayano (KEK),

J. Taguchi, K. Ishida, M. Umehara (Nomura Plating Co, Ltd),

C. E. Reece, and H. Tian (Jefferson National Lab)

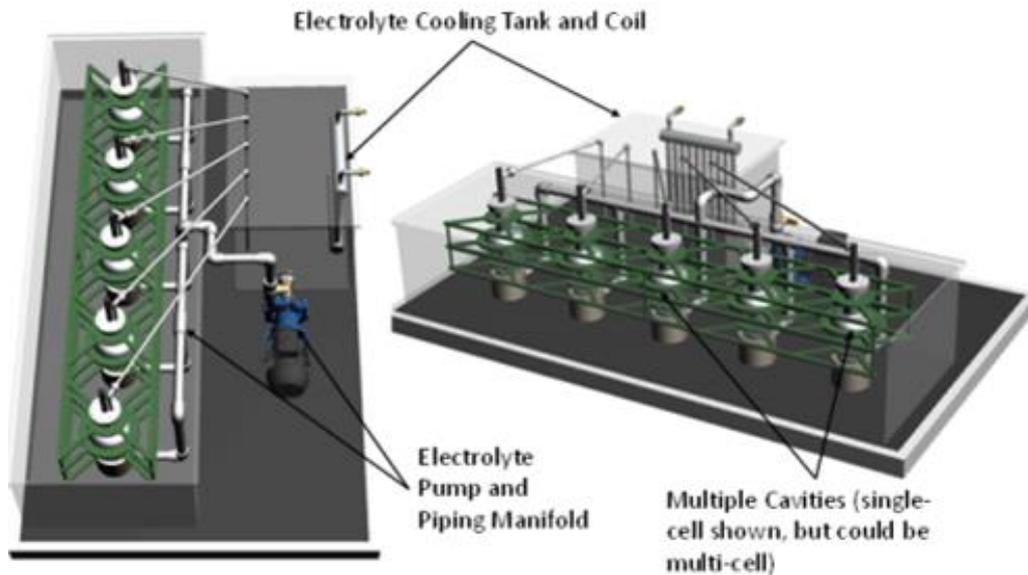
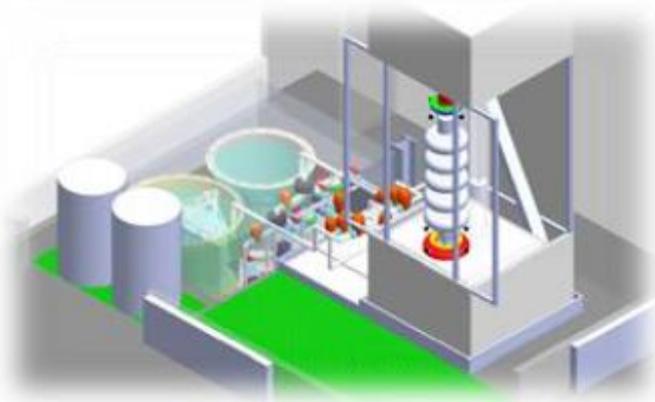
31 May 2017 / 231st ECS Meeting

Symposium: F05: Pulse and Pulse Reverse Electrolytic Processes

Hilton New Orleans Riverside in New Orleans / U.S.A.



3,827 cavities over six years (U.S. portion) to meet the 3,600 cavities required for the ILC

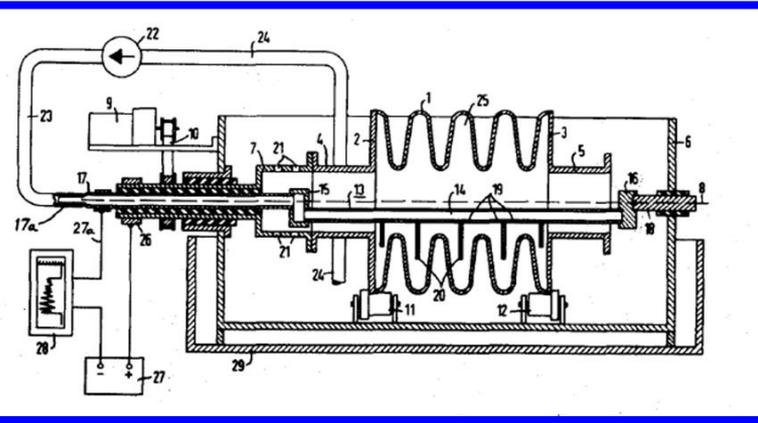


“Industrial” process analogous to plating (electrodeposition) of internal diameters such as those used in aerospace industry.

	Baseline EP	FARADAYIC EP
Electrolyte	9:1 H ₂ SO ₄ :HF	~5% (wt) H ₂ SO ₄ in H ₂ O
Processing Voltage	DC: ~17 V	Pulse Reverse: ~3 V / 9 V
Processing Temperature	25°C	25°C
Cavity Orientation	Horizontal	Vertical
Electrolyte Volume Fill	60%	100%
Electrolyte Flow Rate	~8 L/min	~8 L/min
Cavity Rotation	1 rpm	No Rotation
Cathode Material/Shape	Aluminum/Tube	Mixed-Metal Oxide Coated Titanium/Rod
Material Removal Rate	0.2 μm/min	0.04 μm/min

	Baseline EP	FARADAYIC EP
Operating:		
Acid	\$11,228,418	\$1,125,138
Labor	\$2,965,925	\$1,817,825
Capital:	\$3,186,806	\$1,712,647
TOTAL COST	\$17,381,149	\$4,655,610
Intangible:		
Materials	✗	✓
Environment	✗	✓

E.J. Taylor, M. Inman, T. Hall, S. Snyder, A. Rowe, D. Holmes
 “Economics of Electropolishing Niobium SRF cavities in Eco-Friendly Aqueous Electrolytes without Hydrofluoric Acid” Proceedings of SRF2015 MOPB092 pp. 1-5 Whistler, CANADA (2015).



Prior Art (Seimens)

“Method for the electrolytic polishing of the insdie surface hollow niobium bodies”
 U.S. Patent No. 4,014,765 issued March 29, 1977.

Viscous electrolyte (9:1 H₂SO₄ : HF)

- Horizontal orientation
- Partially filled
- Rotation

➔ Challenge for industrialization

- Electrolyte safety
- High CapEx and OpEx

Intellectual Property Portfolio

- 1st U.S. patent issued, 2nd pending
- Japan & Europe patents issued
- FARADAYIC® registered
 - Trademark
 - Service mark

➔ Independent claim directed towards low viscosity!!

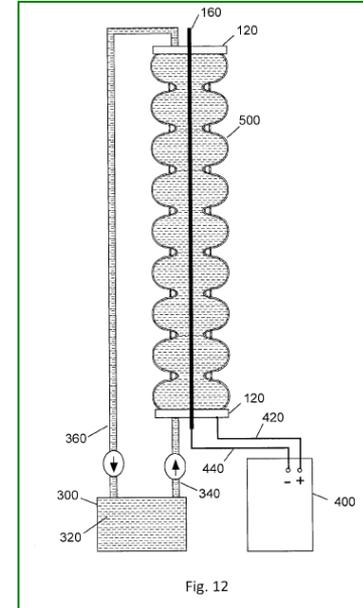


Fig. 12

“Electrochemical system and method for electropolishing superconductive radio frequency cavities”

- U.S. Patent No. 9,006,147 issued April 14, 2015
- Japan Patent No. 6,023,323 issued October 14th 2016
- Europe Patent No. 2,849,908 issued January 15, 2017

Low concentration – aqueous electrolyte (acid/alkaline)

- Vertical orientation
- Completely filled
- No rotation

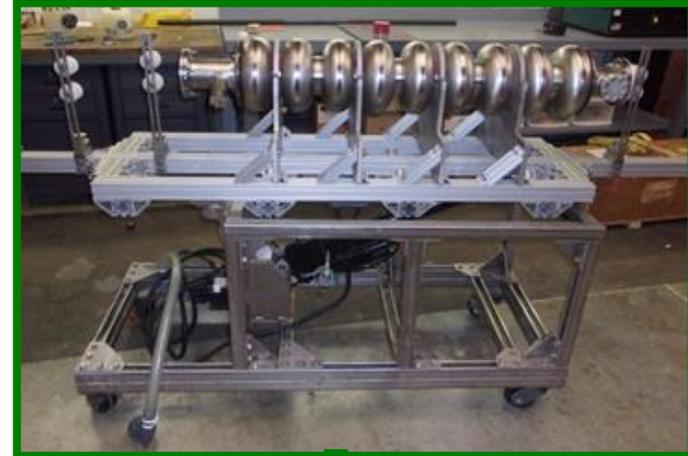
➔ Industrially compatible

- Safe, Low CapEx and OpEx

1. COMPLETELY Acid-Free FARADAYIC® EP
2. High rate EP front-end bulk processing?

Next steps:

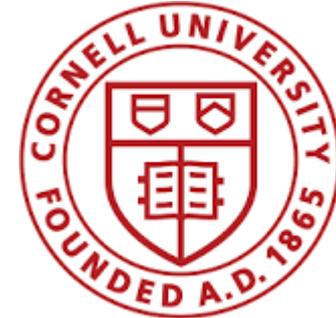
- EP in “button” cell cavity and single-cell SRF cavity
 - Modify bracketing system
 - Drain & neutralize acid
 - Flush supply lines with D.I water
- Construct new external tank for salt solution





Department of Energy (DOE) Funding:

- 1) SBIR Phase I Grant No. DE-SC0004588 (Dr. Manouchehr Farkhondeh),
- 2) SBIR Phase I Grant No. DE-FG02-08ER85053 (Dr. L.K. Ken),
- 3) American Reinvestment in Research Act (ARRA) (Mr. Allan Rowe, Fermi National Accelerator Laboratory),
- 4) SBIR Phase I/II Grant No. DE-SC0011235 (Dr. Manouchehr Farkhondeh),
- 5) SBIR Phase I/II Grant No. DE-SC0011342 (Dr. Kenneth R. Marken, Jr.).



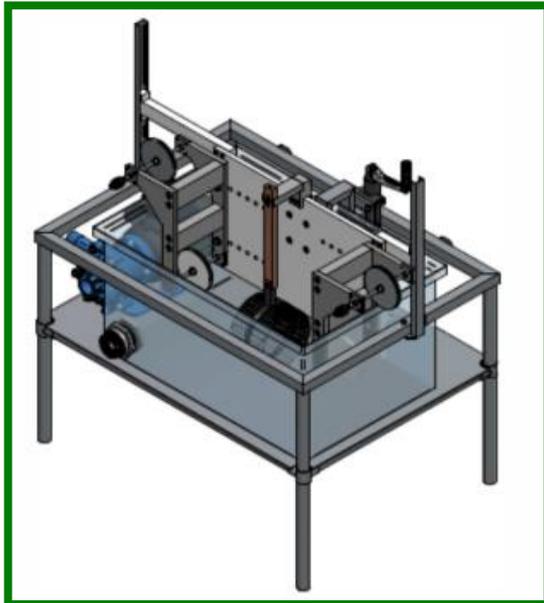
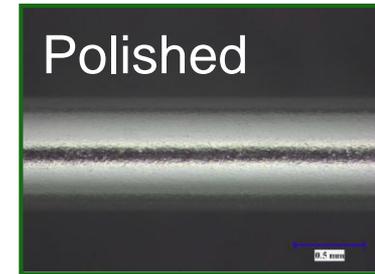
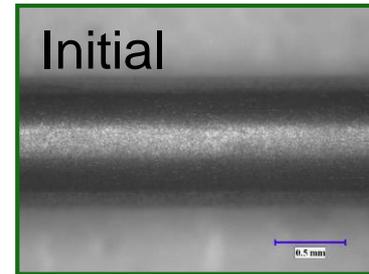
Collaborators:

- 1) Dr. Fumio Furuta and Dr. Geoff Hoffstaetter; Cornell University
- 2) Dr. Hui Tian, Dr. Charles Reece and Dr. Larry Phillips; Jefferson Lab
- 3) Dr. John Mammoser and Dr. Jeff Saunders; Oak Ridge National Laboratory
- 4) Dr. Takayuki Saeki; KEK High Energy Accelerator Research Organization
- 5) Mr. Allan Rowe and Dr. Anna Grassellino; Fermi Laboratory



FARADAYIC® ElectroPolishing of Nitinol medical stents (similarities to Nb)

- Received Phase I & II funding from NIH → process validation
- Project funding from OEM for adaptation to wire
 - α -scale reel-to-reel 300 foot spool trials
- TERM SHEET completed for FoU license
 - Market – Medical
 - Product – Wire based stent/shape sets
 - Material - Nitinol
- LICENSED 4-12-2016





- 1) M. Inman, T. Hall, E.J. Taylor, C.E. Reece, O. Trofimova “Niobium Electropolishing in Aqueous, Non-viscous, HF-FREE Electrolyte: A New Polishing Mechanism” Proceedings of SRF2011 TUPO012 pp. 277-381 Chicago, IL (2011).
- 2) E.J. Taylor, M.E. Inman, T. D. Hall “Electrochemical System and Method for Electropolishing Superconductive Radio Frequency Cavities” U.S. Patent No. 9,006,147 filed July 11, 2012 issued April 14, 2015. (Foreign counterparts pending)
- 3) M. Inman, E.J. Taylor T.D. Hall “Electropolishing of Passive Materials in HF-Free Low Viscosity Aqueous Electrolytes” J. Electrochemical Society 160 (9) E94-E98 (2013).
- 4) A.M. Rowe, A. Grassellino, T.D. Hall, M.E. Inman, S.T. Snyder, E.J. Taylor “Bipolar EP: Electropolishing without Fluorine in a Water Based Electrolyte” Proceedings of SRF2013 TUIOC02 pp. 401-406 Paris, FRANCE (2013).
- 5) E.J. Taylor, M. Inman “Electrochemical Surface Finishing” *Interface* 23(3) pp. 57-61 Fall 2014.
- 6) E.J. Taylor, T. Hall, M. Inman, S. Snyder, A. Rowe “Electropolishing of Niobium SRF Cavities in Low Viscosity Aqueous Electrolytes without Hydrofluoric Acid” Proceedings of SRF2013 TUP054 pp. 534-7 Paris, FRANCE (2015).
- 7) E.J. Taylor, T.D. Hall, S. Snyder, M.E. Inman “Electropolishing of Niobium SRF Cavities in Low-Viscosity, Water-Based, HF-Free Electrolyte: From Coupons to Cavities” Invited Talk 226th Meeting of the Electrochemical Society and XIX Congreso de la Sociedad Mexicana de Electroquímica, MEXICO (2014)
- 8) E.J. Taylor, M.E. Inman, T. D. Hall “Electrochemical System and Method for Electropolishing Superconductive Radio Frequency Cavities” U.S. Patent Appl. No. 14/585,897 filed December 30, 2014.
- 9) E.J. Taylor, M. Inman, T. Hall, S. Snyder, A. Rowe, D. Holmes “Economics of Electropolishing Niobium SRF cavities in Eco-Friendly Aqueous Electrolytes without Hydrofluoric Acid” Proceedings of SRF2015 MOPB092 pp. 1-5 Whistler, CANADA (2015).
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